

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	125	(250/504H).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:42
L5	13	("5420768" "5457611" "5624711" "6102696" "6200134" "6318996" "6331111" "6468077" "6517218" "6523979" "6611110").PN. OR ("6709128"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/05 11:57
L6	8	L4 and (heat near (sink or dissipat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:58
L7	432	(362/119).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:58
L8	12	L7 and (heat near (sink or dissipat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 11:58
L15	2	("20020133970").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:07
L16	14	("4501151" "4748985" "4949708" "5076276").PN. OR ("5213103").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/05 12:18
L17	9	L16 and (epoxy or polymer)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:21

L18	4875	(heat adj sink) same (epoxy or polymer\$2)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:21
L19	530	L18 and (handpiece or (hand adj piece) or handle)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:22
L20	45	L19 and dental	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:26
L21	485	L19 not L20	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:26
L22	79	L21 and medical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:28
L23	406	L21 not L22	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:28
L24	2	L23 and (fill\$3 near handle)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:38
L25	4	L23 and (epoxy near heat)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:48

L26	21	L23 and (light near (cure\$1 or curing))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/05 12:48
S1	46	(heat adj sink) near polymer\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:11
S2	1	S1 and dental	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 17:55
S3	3	S1 and medical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 17:56
S4	6	S1 and (handpiece or tool or (hand adj piece))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 17:56
S5	53	("20020018338" "20020041487" "20020108743" "20020195232" "20040226707" "4619316" "4663649" "4703339" "4888637" "4894060" "4900877" "4926242" "4938279" "4999741" "5006924" "5049085" "5077870" "5168926" "5248748" "5285108" "5315480" "5366688" "5430609" "5440172" "5443876" "5513070" "5523049" "5523260" "5552960" "5572070" "5602221" "5620795" "5653280" "5660917" "5738936" "5745344" "5781412" "5790376" "6026895" "6048919" "6060009" "6093961" "6106922" "6204303" "6280845" "6348654" "6372323" "6385047" "6410137" "6465561" "6547001" "6616999" "6680015").PN. OR ("6919504").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/04 17:59

S6	58	(heat adj sink) near epoxy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:11
S7	0	S6 and dental	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:11
S8	2	S6 and medical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:24
S9	14	("4501151" "4748985" "4949708" "5076276").PN. OR ("5213103").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/04 18:17
S10	12	S6 and (conductive near (epoxy or polymer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:27
S11	800	(433/29).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:27
S12	1	S11 and (heat near (epoxy or polymer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:27
S13	0	S11 and (sink near (epoxy or polymer))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:28
S14	0	S11 and (sink near plastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:28

S15	1	S11 and (heat near plastic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:36
S16	103	S11 and (heat near (sink or dissipat\$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:44
S17	41	S16 and epoxy	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:55
S18	6	S16 and (conducti\$2 near (epoxy or silicone or polymer\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:58
S19	0	S16 and (sink near (epoxy or silicone or polymer\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:59
S20	1	S16 and (heat near (epoxy or silicone or polymer\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/04 18:59